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BSR15

PNP General Purpose Amplifier

- This device designed for use as general purpose amplifier and switches requiring collector currents to 500mA.
- · Sourced from Process 63.
- See BCW68G for Characteristics.



1. Base 2. Emitter 3. Collector

PNP Epitaxial Silicon Transistor

Absolute Maximum Ratings* Ta=25°C unless otherwise noted

Symbol	Parameter	Value	Units
V _{CEO}	Collector-Emitter Voltage	-40	V
V _{CBO}	Collector-Base Voltage	-60	V
V _{EBO}	Emitter-Base Voltage	-5.0	V
Ic	Collector Current - Continuous	-800	mA
T _J , T _{ST}	Operating and Storage Junction Temperature Range	-55 ~ +150	°C

^{*} These ratings are limiting values above which the serviceability of any semiconductor device may be impaired.

These ratings are based on a maximum junction temperature of 150 degrees C.
 These are steady state limits. The factory should be consulted on applications involving pulsed or low duty cycle operations.

Symbol	Parameter	Test Condition	Min.	Тур.	Max.	Units
Off Charact	teristics					
BV _{(BR)CEO}	Collector-Emitter Breakdown Voltage	$I_C = -10 \text{mA}, I_B = 0$	-40			V
BV _{(BR)CBO}	Collector-Base Breakdown Voltage	$I_C = -100\mu A, I_E = 0$	-60			V
BV _{(BR)EBO}	Emitter-Base Breakdown Voltage	$I_E = -10\mu A, I_C = 0$	-5.0			V
I _{CBO}	Collector Cut-off Current	V _{CB} = -50V V _{CB} = -50V, T _A = 150°C			-20 -20	nA μA
I _{CEX}	Collector Cut-off Current	$V_{CE} = -30V, V_{EB} = -0.5V$			-50	nA
I _{BEX}	Reverse Base Current	$V_{CE} = -30V, V_{EB} = -3.0V$			-50	nA
On Charact	teristics	-		,		•
h _{FE}	DC Current Gain	$\begin{split} I_C &= -0.1 \text{mA}, \ V_{CE} = -10 \text{V} \\ I_C &= -1.0 \text{mA}, \ V_{CE} = -10 \text{V} \\ I_C &= -10 \text{mA}, \ V_{CE} = -10 \text{V} \\ I_C &= -150 \text{mA}, \ V_{CE} = -10 \text{V} \\ I_C &= -500 \text{mA}, \ V_{CE} = -10 \text{V} \\ \end{split}$	35 50 75 100 30	300		
V _{CE} (sat)	Collector-Emitter Saturation Voltage	I _C = -150mA, I _B = -15mA I _C = -500mA, I _B = -50mA			-0.4 -1.6	V
V _{BE} (sat)	Base-Emitter Saturation Voltage	I _C = -150mA, I _B = -15mA I _C = -500mA, I _B = -50mA			-1.3 -2.6	V
Small Signa	al Characteristics					
f _T	Current Gain Bandwidth Product	I _C = -50mA, V _{CE} = -20V, f = 100MHz, T _A = 25°C	200			MHz
C _{cb}	Output Capacitance	$V_{CB} = -10V, I_{E} = 0, f = 1.0MHz$			8.0	pF
C _{eb}	Emitter-Base Capacitance	$V_{CB} = -2.0V, I_{E} = 0, f = 1.0MHz$			30	pF
Switching (Characteristics					
t _{on}	Turn-On Time	$V_{CC} = -30V, I_{C} = -150mA,$			45	ns
t _d	Delay Time	I _{B1} = -15mA			10	ns
t _r	Rise Time]			40	ns
t _{off}	Turn-Off Time	$V_{CC} = -30V, I_{C} = -150mA,$			100	ns
t _s	Storage Time	$I_{B1} = I_{B2} = -15mA$			80	ns
		1				t

Thermal Characteristics $T_A=25\,^{\circ}C$ unless otherwise noted

Symbol	Parameter	Max.	Units
P _D	Total Device Dissipation	350	mW
	Derate above 25°C	2.8	mW/°C
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient	357	°C/W

^{*} Device mounted on FR-4 PCB 40mm × 40mm × 1.5mm

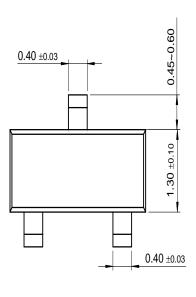
Fall Time

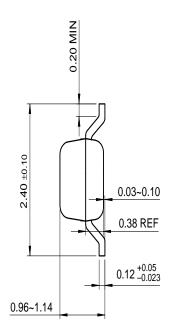
30

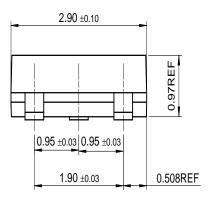
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Package Dimensions

SOT-23







Dimensions in Millimeters

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